



Features

- For surface mounted applications in order to optimize board space.
- Low profile package.
- Glass passivated junction.
- Low inductance.
- Plastic package has Underwriters Laboratory Flammability.



SOD-123FL
(SMF)

Mechanical Data

- Case: JEDEC SOD-123FL/SMF molded plastic body
- Terminals: Solderable per MIL-STD-750, Method 2026A
- Polarity: Polarity symbol marking on body
- Mounting Position: Any
- Weight: $0.00 \leq 7$ ounce, 0.02 grams
- Marking: Date Code and Marking Code See Page 2

Applications

- I/O interface
- AC/DC power supply
- Low frequency signal transmission line (RS232, RS485, etc.)

Maxmim Ratings (Ta=25°C unless otherwise noted)

Peak pulse power dissipation at 10/1000μs waveform (Note1, Note2, Fig.1)	P_{PPM}	200	W
Peak pulse current	I_{PP}	3.4	A
Steady state power dissipation at $T_A=50^{\circ}\text{C}$ (Fig.5)	$P_{M(AV)}$	1.0	W
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load, (JEDEC Method) (Note3, Fig.6)	I_{FSM}	30	A
Operating junction and Storage Temperature Range.	T_J, T_{STG}	-65 to +150	$^{\circ}\text{C}$
Typical thermal resistance junction to lead	$R_{\theta JL}$	38	$^{\circ}\text{C/W}$
Typical thermal resistance junction to ambient	$R_{\theta JA}$	180	$^{\circ}\text{C/W}$

Notes: 1. Non-repetitive current pulse, per Fig.3 and derated above $T_A=25^{\circ}\text{C}$ per Fig.2.
2. Mounted on 5.0mm×5.0mm (0.03mm thick) copper pads to each terminal.
3. 8.3ms single half sine-wave, or equivalent square wave, duty cycle=4 pulses per minutes maximum.

Electrical Characteristics (Ta=25°C)

Part Number		Device Marking Code		Reverse Stand- Off Voltage	Breakdown Voltage @ I_T	Test Current	Maximum Clamping Voltage @ I_{PP}	Peak Pulse Current	Reverse Leakage @ V_{RWM}
Unidirectional	Bidirectional	UNI	BI	$V_{RWM}(V)$	$V_{BR}(V)$	$I_T(mA)$	$V_C(V)$	$I_{PP}(A)$	$I_R(\mu A)$
HSZSMF36AT1G	HSZSMF36CAT1G	CP	PP	36	40-44.2	1	58.1	3.4	1



Ratings and Characteristic Curves ($T_A=25^{\circ}\text{C}$ unless otherwise noted)

Fig.1 Peak Pulse Power Rating Curve

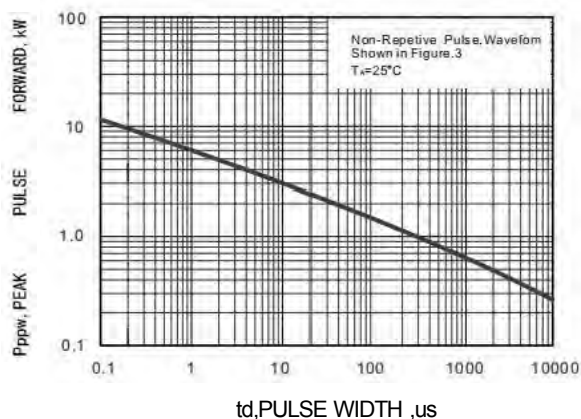


Fig.2 Forward Current Derating Curve

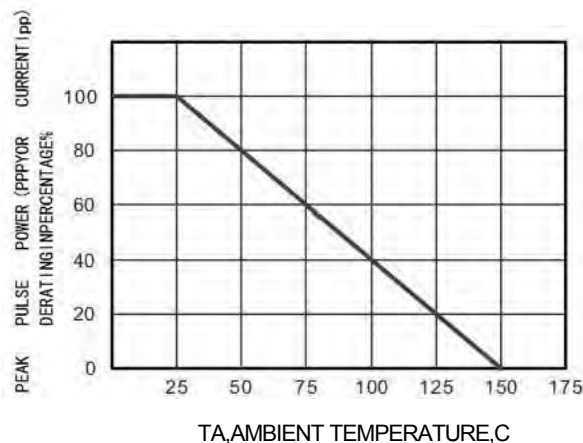


Fig.3 Pulse Waveform

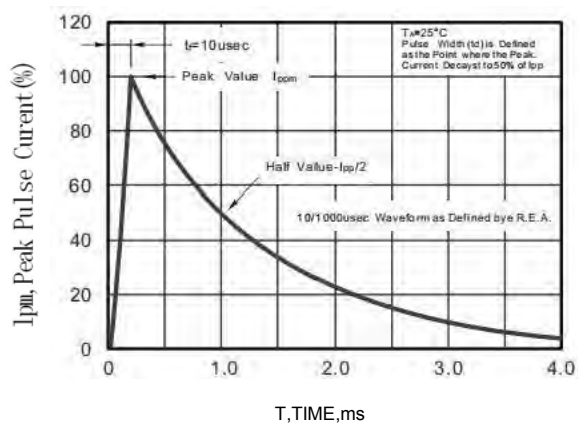
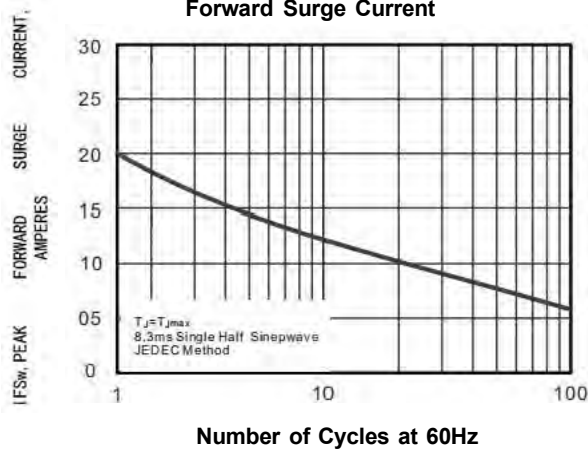
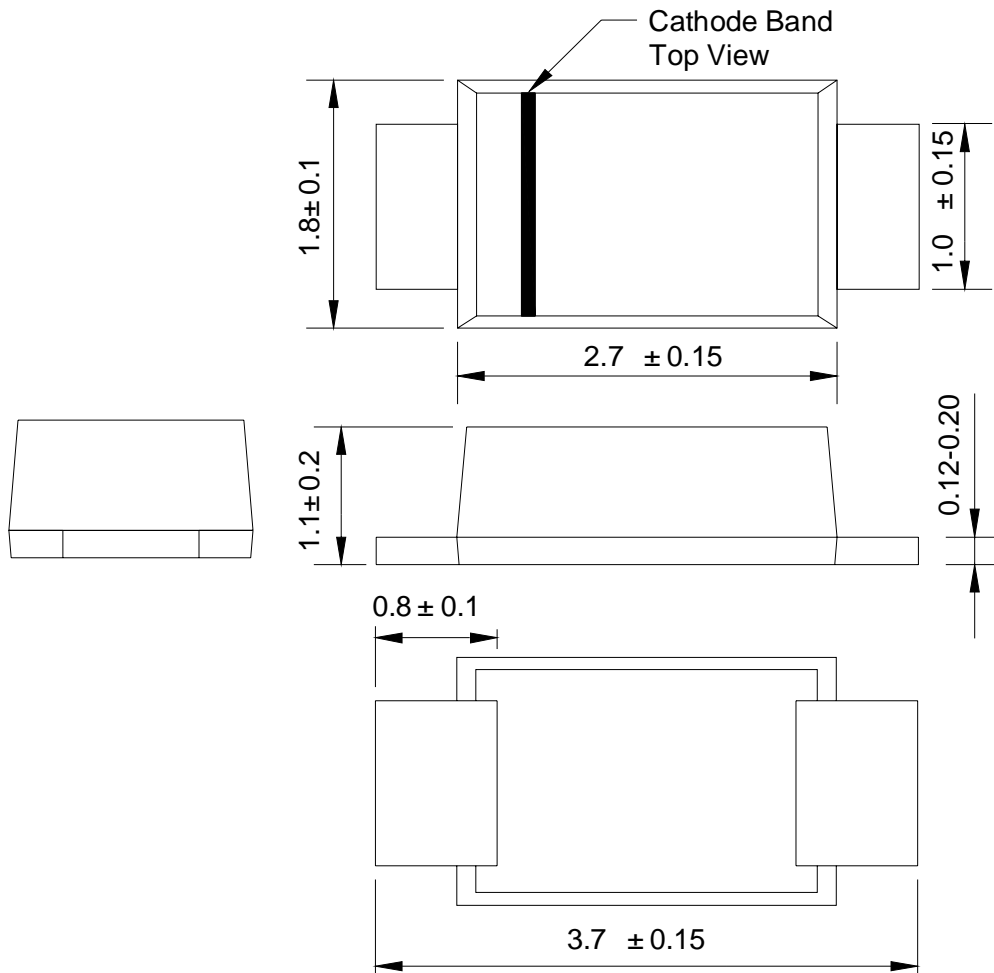


Fig.4 Maximum Non-Repetitive Peak Forward Surge Current





Package Outline Dimensions
SOD-123FL(SMF)





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